

L Number	Hits	Search Text	DB	Time stamp
1	2	((("20020014702") or ("20020031902")).PN.	USPAT; US-PGPUB	2004/07/22 16:53
2	2118	438/107,108,118,455,612,613.ccls. and @ad<20000310	USPAT; US-PGPUB	2004/07/22 17:03
3	2037	(438/107,108,118,455,612,613.ccls. and @ad<20000310) and (chip or substrate or wafer)	USPAT; US-PGPUB	2004/07/22 17:03
4	1476	((438/107,108,118,455,612,613.ccls. and @ad<20000310) and (chip or substrate or wafer)) and (bump or electrode or solder)	USPAT; US-PGPUB	2004/07/22 17:03
5	1522	257/778-780.ccls. and @ad<20000310	USPAT; US-PGPUB	2004/07/22 17:03
6	1484	(257/778-780.ccls. and @ad<20000310) and (chip or substrate or wafer)	USPAT; US-PGPUB	2004/07/22 17:03
8	1383	((257/778-780.ccls. and @ad<20000310) and (chip or substrate or wafer)) and (bump or electrode or solder)	USPAT; US-PGPUB	2004/07/22 17:04
9	1236	((257/778-780.ccls. and @ad<20000310) and (chip or substrate or wafer)) and (bump or electrode or solder)) not ((438/107,108,118,455,612,613.ccls. and @ad<20000310) and (chip or substrate or wafer)) and (bump or electrode or solder))	USPAT; US-PGPUB	2004/07/22 17:04